

UF9Z24-F

Power MOSFET

**-12A, -55V P-CHANNEL
POWER MOSFET**

■ DESCRIPTION

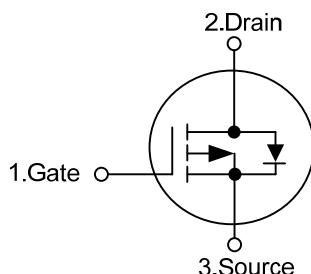
The UTC **UF9Z24-F** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed, cost-effectiveness and minimum on-state resistance. It can also withstand high energy in the avalanche.

■ FEATURES

* $R_{DS(ON)} \leq 150 \text{ m}\Omega @ V_{GS}=-10\text{V}, I_D=-7.2\text{A}$

* High Switching Speed

■ SYMBOL



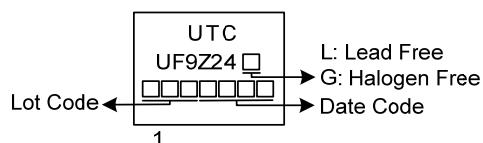
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UF9Z24L-TA3-T	UF9Z24G-TA3-T	TO-220	G	D	S	Tube
UF9Z24L-TN3-R	UF9Z24G-TN3-R	TO-252	G	D	S	Tape Reel
UF9Z24L-TQ2-T	UF9Z24G-TQ2-T	TO-263	G	D	S	Tube
UF9Z24L-TQ2-R	UF9Z24G-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

UF9Z24G-TA3-T 	(1)Packing Type (2)Package Type (3)Green Package	(1) T: Tube, R: Tape Reel (2) TA3: TO-220, TN3: TO-252, TQ2: TO-263 (3) G: Halogen Free and Lead Free, L: Lead Free
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_C=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	-55	V
Gate-Source Voltage		V_{GSS}	± 20	V
Drain Current	Continuous	I_D	-12	A
	Pulsed	I_{DM}	-24	A
Single Pulsed Avalanche Energy (Note 3)		E_{AS}	390	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.2	V/ns
Power Dissipation	TO-220/TO-263	P_D	60	W
	TO-252		25	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L=30\text{mH}$, $I_{AS}=-5.1\text{A}$, $V_{DD}=-50\text{V}$, $R_G=25\Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD}\leq -12\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-263	θ_{JA}	62.5	$^\circ\text{C/W}$
	TO-252		110	$^\circ\text{C/W}$
Junction to Case	TO-220/TO-263	θ_{JC}	2.1	$^\circ\text{C/W}$
	TO-252		5	$^\circ\text{C/W}$

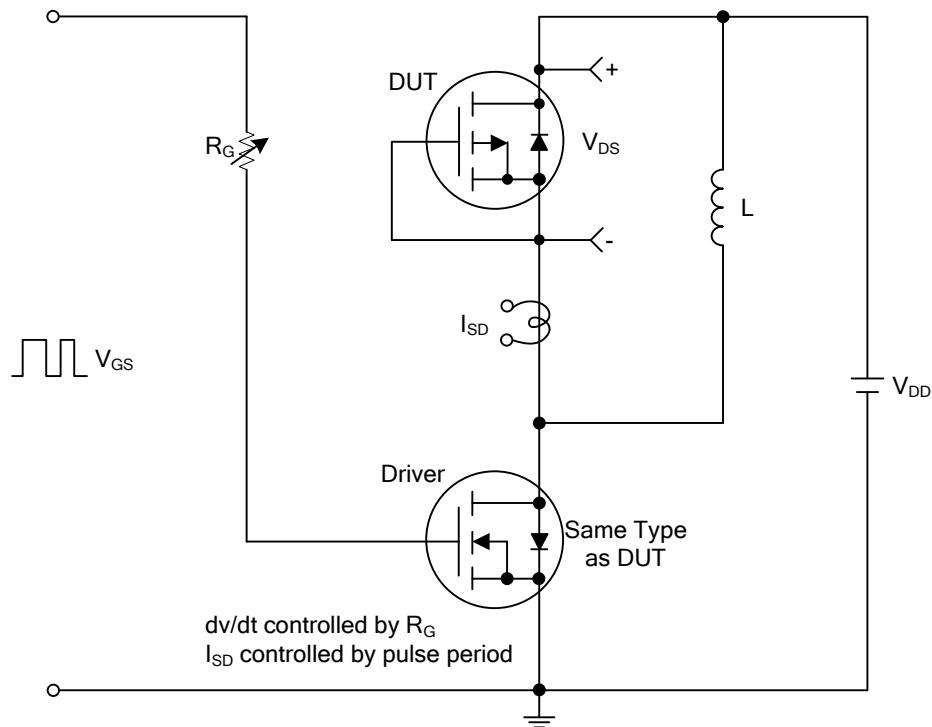
■ Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$I_D=-250\mu\text{A}, V_{GS}=0\text{V}$	-55			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-55\text{V}, V_{GS}=0\text{V}$		-1		μA
Gate-Source Leakage Current	Forward	$V_{GS}=+20\text{V}$		+100	nA	
	Reverse	$V_{GS}=-20\text{V}$		-100	nA	
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-2.0		-4.0	V
Static Drain-Source On-State Resistance	$R_{DS(\text{ON})}$	$V_{GS}=-10\text{V}, I_D=-7.2\text{A}$ (Note 1)		150		$\text{m}\Omega$
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=-25\text{V}, f=1.0\text{MHz}$ (Note 2)		640		pF
Output Capacitance	C_{OSS}			180		pF
Reverse Transfer Capacitance	C_{RSS}			40		pF
SWITCHING PARAMETERS						
Total Gate Charge (Note 1)	Q_G	$V_{DS}=-44\text{V}, V_{GS}=-10\text{V}, I_D=-12\text{A}$ $V_{DD}=-30\text{V}, I_D=-12\text{A}, R_G=25\Omega$		19.3		nC
Gate to Source Charge	Q_{GS}			3		nC
Gate to Drain Charge	Q_{GD}			6		nC
Turn-ON Delay Time (Note 1)	$t_{D(\text{ON})}$			6.8		ns
Rise Time	t_R			17		ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$			20		ns
Fall-Time	t_F			17		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS (Note 2)						
Maximum Body-Diode Continuous Current	I_S				-12	A
Maximum Body-Diode Pulsed Current	I_{SM}				-24	A
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0\text{V}, I_S=-12\text{A}$ (Note 1)			-1.6	V
Body Diode Reverse Recovery Time (Note 1)	t_{rr}	$V_{GS}=0\text{V}, I_S=-12\text{A}$		48		ns
Body Diode Reverse Recovery Charge	Q_{rr}	$dI_F/dt=100\text{A}/\mu\text{s}$		85		nC

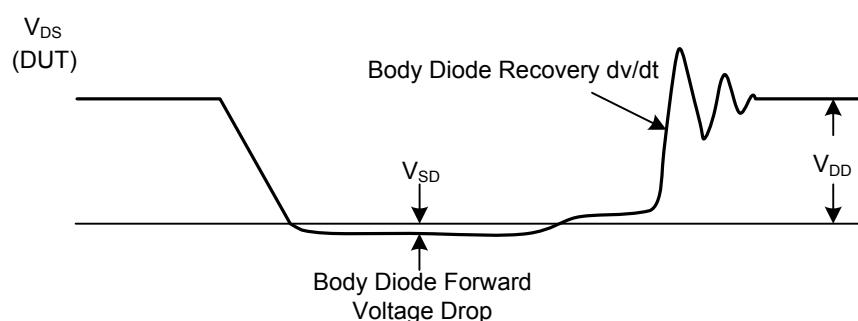
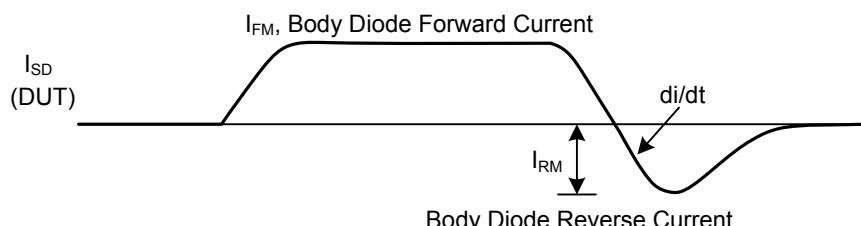
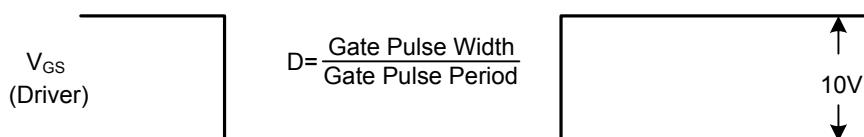
Notes: 1. Pulse Test: Pulse width $\leq 300\mu\text{s}$, Duty cycle $\leq 2\%$.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS



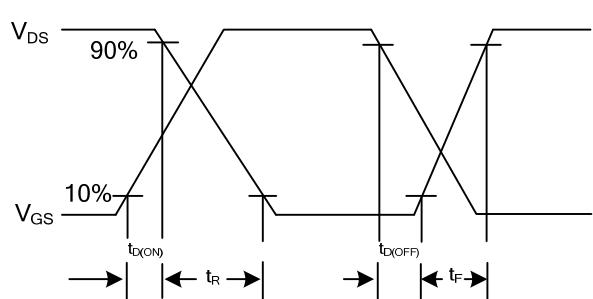
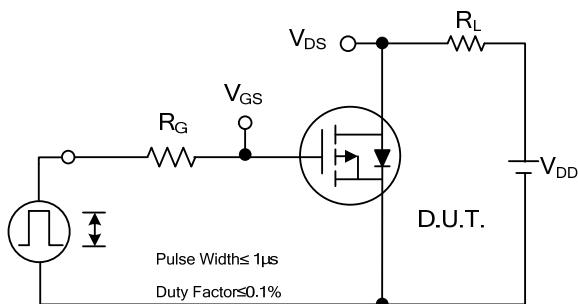
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Test Circuit and Waveforms

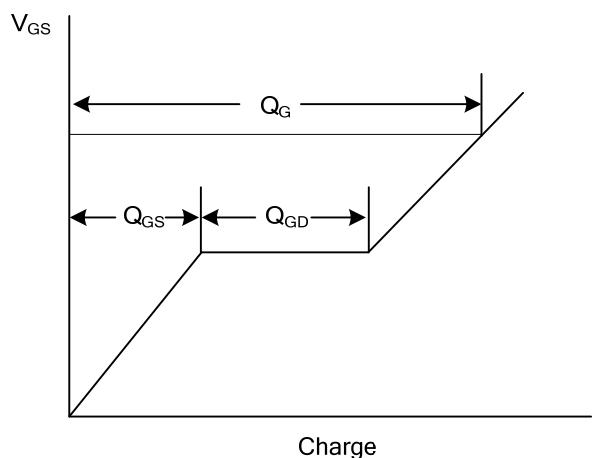
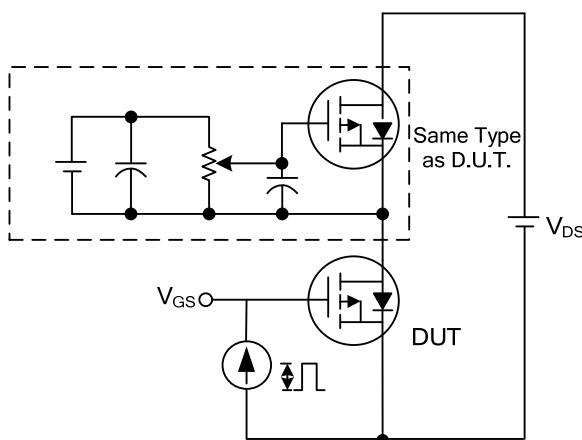
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS



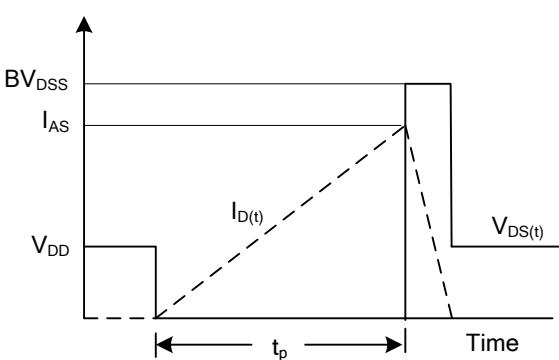
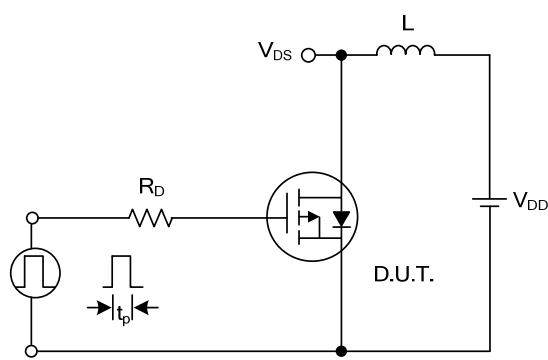
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

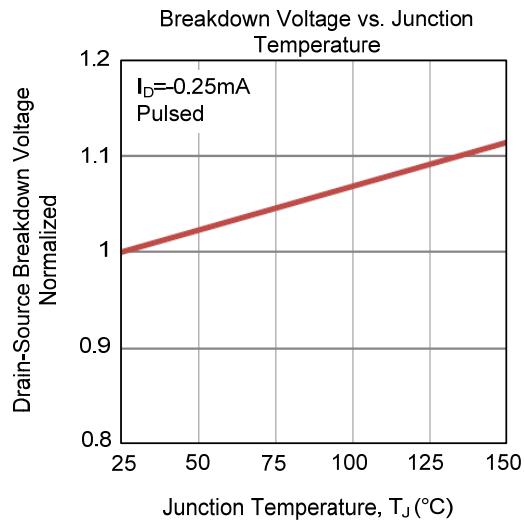
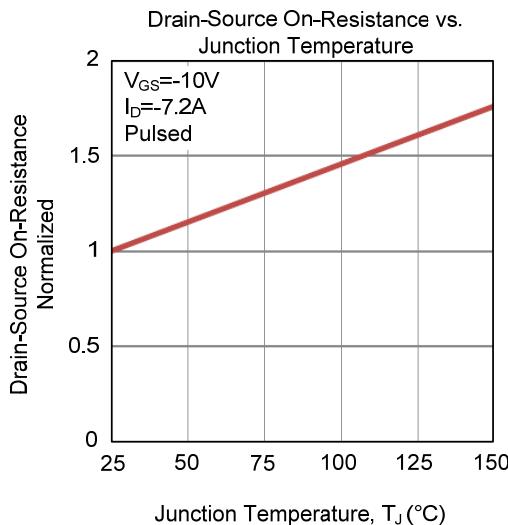
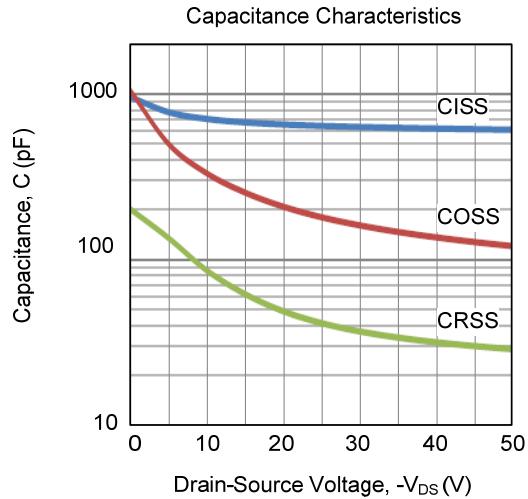
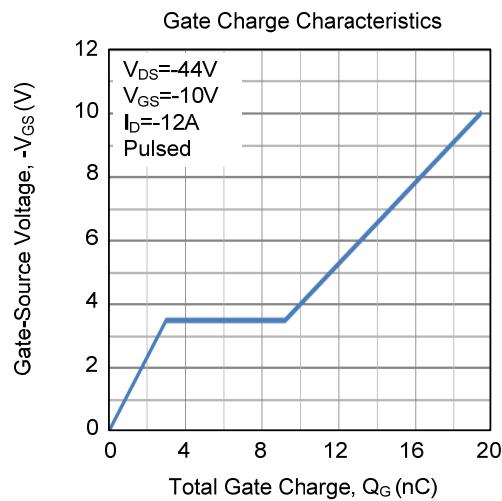
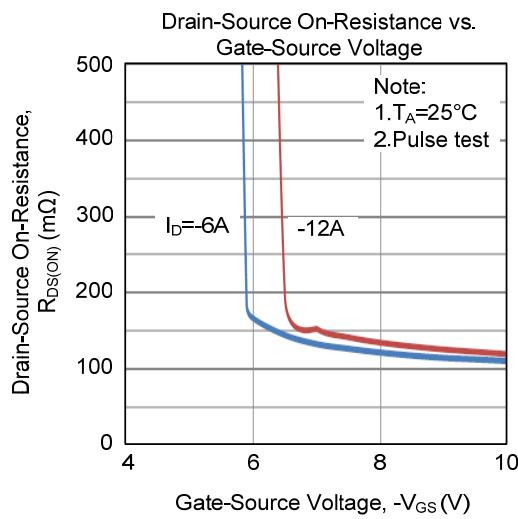
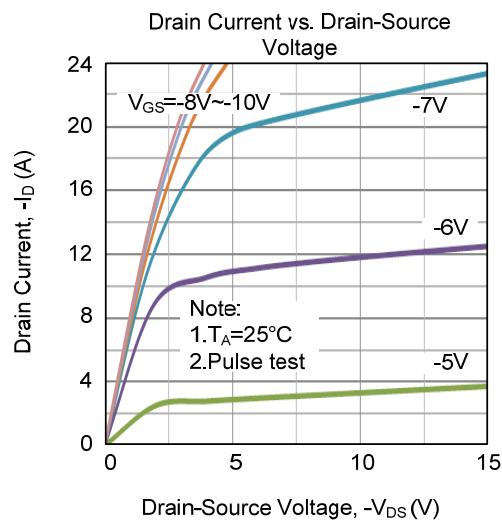
Gate Charge Waveform



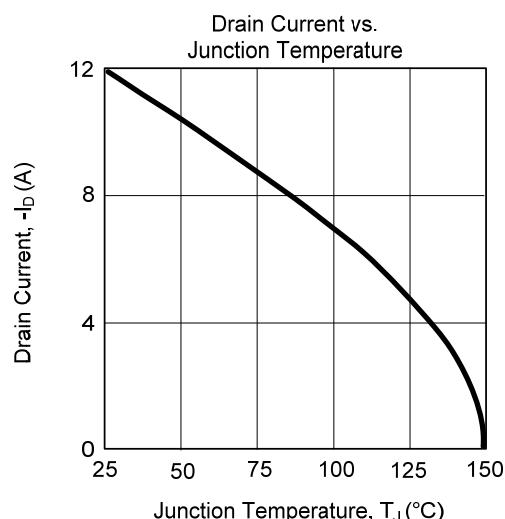
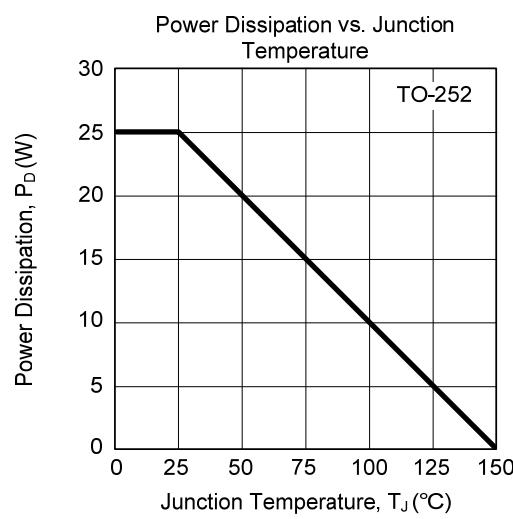
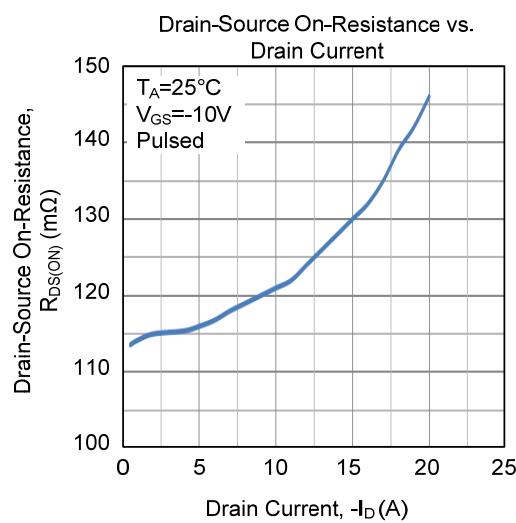
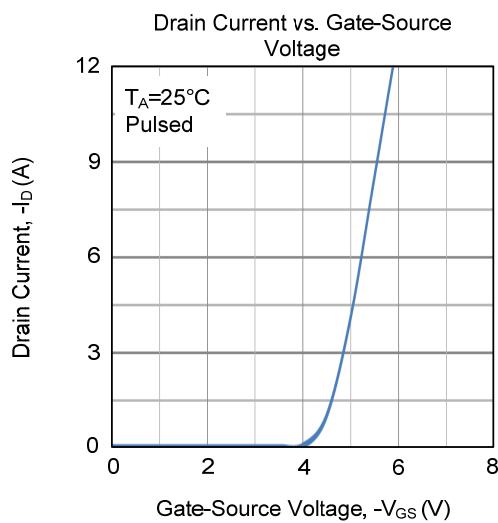
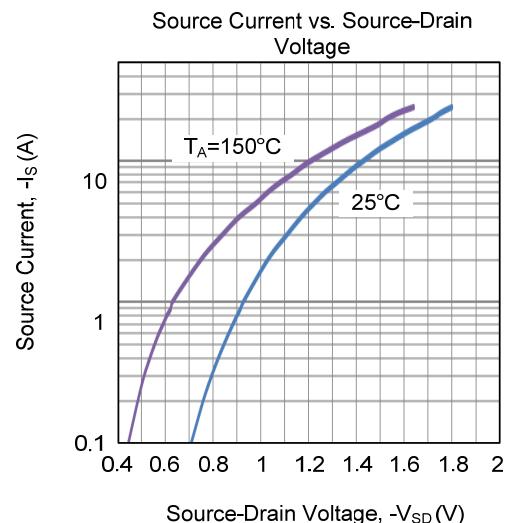
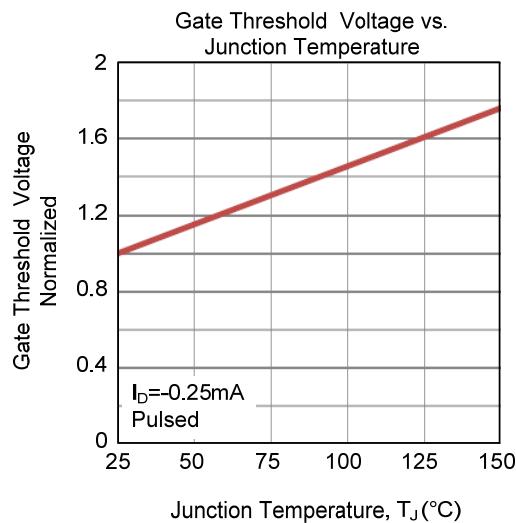
Unclamped Inductive Switching Test Circuit

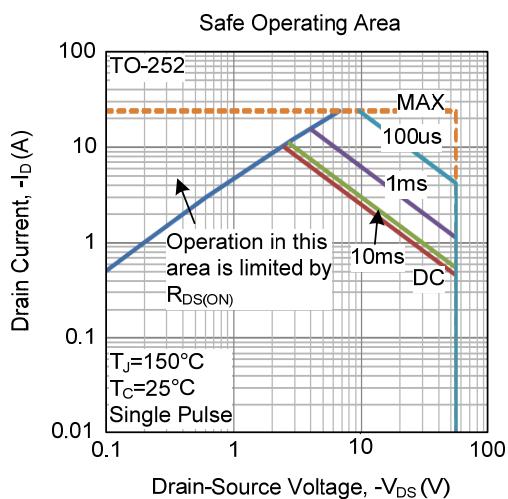
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)

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